

Part no. **BC-A-1/13-TW-A**  
 Catalog No. **101562**

## Design verification as per IEC/EN 61439

Technical data for design verification			
Heat dissipation, at an ambient temperature of 35°C, delta T: 20 degrees in top of the enclosure, calculated as per IEC 60890			
Individual enclosure for wall mounting	P <sub>V</sub>	W	13
Heat dissipation, at an ambient temperature of 35°C, delta T: 35 degrees in top of the enclosure, calculated as per IEC 60890			
Individual enclosure for wall mounting	P <sub>V</sub>	W	26
IEC/EN 61439 design verification			
10.2 Strength of materials and parts			
10.2.2 Corrosion resistance			Meets the product standard's requirements.
10.2.3.1 Verification of thermal stability of enclosures			Meets the product standard's requirements.
10.2.3.2 Verification of resistance of insulating materials to normal heat			Meets the product standard's requirements.
10.2.3.3 Verification of resistance of insulating materials to abnormal heat and fire due to internal electric effects			650 °C; meets the product standard's requirements.
10.2.4 Resistance to ultra-violet (UV) radiation			Not relevant to indoor installations.
10.2.5 Lifting			Does not apply to enclosures without lifting aids.
10.2.6 Mechanical impact			IK07
10.2.7 Inscriptions			Meets the product standard's requirements.
10.3 Degree of protection of ASSEMBLIES			IP40
10.4 Clearances and creepage distances			Is the panel builder's responsibility.
10.5 Protection against electric shock			Does not apply to plastic enclosures.
10.6 Incorporation of switching devices and components			Is the panel builder's responsibility.
10.7 Internal electrical circuits and connections			Is the panel builder's responsibility.
10.8 Connections for external conductors			Is the panel builder's responsibility.
10.9 Insulation properties			
10.9.2 Power-frequency electric strength			U <sub>i</sub> = 440 V AC
10.9.3 Impulse withstand voltage			4 kV
10.9.4 Testing of enclosures made of insulating material			Meets the product standard's requirements.
10.10 Temperature rise			The panel builder is responsible for the temperature rise calculation. Eaton will provide heat dissipation data for the devices.
10.11 Short-circuit rating			Is the panel builder's responsibility.
10.12 Electromagnetic compatibility			Is the panel builder's responsibility.
10.13 Mechanical function			Meets the product standard's requirements.

## Technical data ETIM 8.0

Distribution boards (EG000023) / Small distribution board (EC000214)			
Electric engineering, automation, process control engineering / Electrical installation, device / Electrical distribution system (incl. small distribution board) / Small distribution board (ec1@ss10.0.1-27-14-24-09 [ACN387011])			
Mounting method			Surface mounted (plaster)
Number of rows			1
Width in number of modular spacings			13
Type of cover			Door
Cover model			With notch
Transparent cover/door			No
Material housing			Plastic
Height		mm	230
Width		mm	260
Depth		mm	130
Built-in depth		mm	46

Built-in height		mm	0
Built-in width		mm	234
Internal depth		mm	72
Earthing terminal block			No
Neutral terminal block			No
DIN-rail			Yes
With mounting plate			No
Extension possible			No
EMC-version			No
Colour			White
RAL-number			9010
Degree of protection (IP)			IP40
With lock			No
Type of closure			Other
Signal passing door			No